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PATENT NUMBER and
ISSUE DATE

U.S. UTILITY Patent Application

APPL NUM 10084389	FILING DATE 02/25/2002	CLASS 526	SUBCLASS C1	GAU 1742	EXAMINER inc L. N. N. N.
**APPLICANTS: Dershem Stephen; Patterson Dennis; Osuna Jose;					
**CONTINUING DATA VERIFIED: THIS APPLICATION IS A CON OF 09/580,026 05/26/2000 WHICH IS A CIP OF 08/300,721 09/02/1994 PAT 6,034,194					
** FOREIGN APPLICATIONS VERIFIED:					
PG-PUB <input type="checkbox"/> DO NOT PUBLISH <input type="checkbox"/>		RESCIND <input type="checkbox"/>			
Foreign priority claimed <input type="checkbox"/> yes <input type="checkbox"/> no		35 USC 119 conditions met <input type="checkbox"/> yes <input type="checkbox"/> no		ATTORNEY DOCKET NO	
Verified and Acknowledged Examiners's initials				QUANT1190-3 (028248-1010)	
TITLE : Thermosetting resin compositions containing maleimide and/or vinyl compounds					

NOTICE OF ALLOWANCE MAILED		CLAIMS ALLOWED	
		Total Claims	Print Claim for O.G
ISSUE FEE		DRAWING	
Amount Due	Date Paid	Sheets Drwg.	Figs. Drwg.
		Print Fig.	
<input type="checkbox"/> TERMINAL DISCLAIMER		Application Examiner	
		PREPARED FOR ISSUE	
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